Zilog - Z8F011AHJ020EG Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	1KB (1K x 8)
Program Memory Type	FLASH
EEPROM Size	16 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.173", 4.40mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f011ahj020eg

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tor address. Following Stop Mode Recovery, the STOP bit in the Reset Status (RSTSTAT) Register is set to 1. Table 10 lists the Stop Mode Recovery sources and resulting actions. The text following provides more detailed information about each of the Stop Mode Recovery sources.

Table 10. Stop Mode Recovery Sources and Resulting Action

Operating Mode	Stop Mode Recovery Source	Action
STOP Mode	Watchdog Timer time-out when configured for Reset	Stop Mode Recovery
	Watchdog Timer time-out when configured for interrupt	Stop Mode Recovery followed by interrupt (if interrupts are enabled)
	Data transition on any GPIO port pin enabled as a Stop Mode Recovery source	Stop Mode Recovery
	Assertion of external $\overline{\text{RESET}}$ Pin	System Reset
	Debug Pin driven Low	System Reset

Stop Mode Recovery Using Watchdog Timer Time-Out

If the Watchdog Timer times out during STOP Mode, the device undergoes a Stop Mode Recovery sequence. In the Reset Status (RSTSTAT) Register, the WDT and STOP bits are set to 1. If the Watchdog Timer is configured to generate an interrupt upon time-out and the Z8 Encore! XP F082A Series device is configured to respond to interrupts, the eZ8 CPU services the Watchdog Timer interrupt request following the normal Stop Mode Recovery sequence.

Stop Mode Recovery Using a GPIO Port Pin Transition

Each of the GPIO port pins may be configured as a Stop Mode Recovery input source. On any GPIO pin enabled as a Stop Mode Recovery source, a change in the input pin value (from High to Low or from Low to High) initiates Stop Mode Recovery.

Note: SMR pulses shorter than specified do not trigger a recovery (see Table 135 on page 233). In this instance, the STOP bit in the Reset Status (RSTSTAT) Register is set to 1.

Caution: In STOP Mode, the GPIO Port Input Data registers (PxIN) are disabled. The Port Input Data registers record the Port transition only if the signal stays on the Port pin through the end of the Stop Mode Recovery delay. As a result, short pulses on the Port pin can initiate Stop Mode Recovery without being written to the Port Input Data Register or

Port A–D Alternate Function Subregisters

The Port A–D Alternate Function Subregister, shown in Table 22, is accessed through the Port A–D Control Register by writing 02H to the Port A–D Address Register. The Port A–D Alternate Function subregisters enable the alternate function selection on pins. If disabled, pins functions as GPIO. If enabled, select one of four alternate functions using alternate function set subregisters 1 and 2 as described in the **the** Port A–D Alternate Function Set 1 Subregisters **section on page 50**, the GPIO Alternate Functions section on page 37 and **the** Port A–D Alternate Function Set 2 Subregisters **section on page 51.** See the GPIO Alternate Functions section on page 37 to determine the alternate function associated with each port pin.

! **Caution:** Do not enable alternate functions for GPIO port pins for which there is no associated alternate function. Failure to follow this guideline can result in unpredictable operation.

Table 22. Port A–D Alternate Function Subregisters (PxAF)

Bit	7	6	5	4	3	2	1	0
Field	AF7	AF6	AF5	AF4	AF3	AF2	AF1	AF0
RESET	00H (Ports A–C); 01H (Port D); 04H (Port A of 8-pin device)							
R/W	R/W							
Address	If 02H in Port A–D Address Register, accessible through the Port A–D Control Register							

Bit	Description
[7:0] AFx	**Port Alternate Function Enabled** 0 = The port pin is in normal mode and the DDx bit in the Port A–D Data Direction subregister determines the direction of the pin. 1 = The alternate function selected through Alternate Function Set subregisters is enabled. Port pin operation is controlled by the alternate function.

Note: x indicates the specific GPIO port pin number (7–0).

Port A–D Output Control Subregisters

The Port A–D Output Control Subregister, shown in Table 23, is accessed through the Port A–D Control Register by writing 03H to the Port A–D Address Register. Setting the bits in the Port A–D Output Control subregisters to 1 configures the specified port pins for open-drain operation. These subregisters affect the pins directly and, as a result, alternate functions are also affected.

Interrupt Control Register

The Interrupt Control (IRQCTL) Register, shown in Table 49, contains the master enable bit for all interrupts.

Table 49. Interrupt Control Register (IRQCTL)

Bit	7	6	5	4	3	2	1	0
Field	IRQE	Reserved						
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R	R	R	R	R	R	R
Address	FCFH							

Bit	Description
[7] IRQE	**Interrupt Request Enable** This bit is set to 1 by executing an EI (Enable Interrupts) or IRET (Interrupt Return) instruction, or by a direct register write of a 1 to this bit. It is reset to 0 by executing a DI instruction, eZ8 CPU acknowledgement of an interrupt request, Reset or by a direct register write of a 0 to this bit. 0 = Interrupts are disabled. 1 = Interrupts are enabled.
[6:0]	**Reserved** These bits are reserved and must be programmed to 0000000.

Timers

These Z8 Encore! XP F082A Series products contain two 16-bit reloadable timers that can be used for timing, event counting, or generation of pulse-width modulated (PWM) signals. The timers' feature include:

- 16-bit reload counter
- Programmable prescaler with prescale values from 1 to 128
- PWM output generation
- Capture and compare capability
- External input pin for timer input, clock gating, or capture signal. External input pin signal frequency is limited to a maximum of one-fourth the system clock frequency
- Timer output pin
- Timer interrupt

In addition to the timers described in this chapter, the Baud Rate Generator of the UART (if unused) may also provide basic timing functionality. For information about using the Baud Rate Generator as an additional timer, see the Universal Asynchronous Receiver/ Transmitter chapter on page 99.

Architecture

Figure 9 displays the architecture of the timers.

Table 52. Timer 0–1 High Byte Register (TxH)

Bit	7	6	5	4	3	2	1	0
Field	TH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F00H, F08H							

Table 53. Timer 0–1 Low Byte Register (TxL)

Bit	7	6	5	4	3	2	1	0
Field	TL							
RESET	0	0	0	0	0	0	0	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F01H, F09H							

Bit	Description
[7:0] TH, TL	**Timer High and Low Bytes** These 2 bytes, {TH[7:0], TL[7:0]}, contain the current 16-bit timer count value.

WDT Reset in Normal Operation

If configured to generate a Reset when a time-out occurs, the Watchdog Timer forces the device into the System Reset state. The WDT status bit in the Reset Status (RSTSTAT) Register is set to 1. For more information about system reset, see the Reset, Stop Mode Recovery and Low Voltage Detection chapter on page 22.

WDT Reset in STOP Mode

If configured to generate a Reset when a time-out occurs and the device is in STOP Mode, the Watchdog Timer initiates a Stop Mode Recovery. Both the WDT status bit and the STOP bit in the Reset Status (RSTSTAT) Register are set to 1 following WDT time-out in STOP Mode.

Watchdog Timer Reload Unlock Sequence

Writing the unlock sequence to the Watchdog Timer (WDTCTL) Control Register address unlocks the three Watchdog Timer Reload Byte registers (WDTU, WDTH and WDTL) to allow changes to the time-out period. These write operations to the WDTCTL Register address produce no effect on the bits in the WDTCTL Register. The locking mechanism prevents spurious writes to the Reload registers. Observe the following steps to unlock the Watchdog Timer Reload Byte registers (WDTU, WDTH and WDTL) for write access.

1. Write 55H to the Watchdog Timer Control Register (WDTCTL).
2. Write AAH to the Watchdog Timer Control Register (WDTCTL).
3. Write the Watchdog Timer Reload Upper Byte Register (WDTU) with the appropriate time-out value.
4. Write the Watchdog Timer Reload High Byte Register (WDTH) with the appropriate time-out value.
5. Write the Watchdog Timer Reload Low Byte Register (WDTL) with the appropriate time-out value.

All three Watchdog Timer Reload registers must be written in the order just listed. There must be no other register writes between each of these operations. If a register write occurs, the lock state machine resets and no further writes can occur unless the sequence is restarted. The value in the Watchdog Timer Reload registers is loaded into the counter when the Watchdog Timer is first enabled and every time a WDT instruction is executed.

Watchdog Timer Calibration

Due to its extremely low operating current, the Watchdog Timer oscillator is somewhat inaccurate. This variation can be corrected using the calibration data stored in the Flash Information Page; see Tables 100 and 101 on page 173 for details. Loading these values

Table 69. UART Address Compare Register (U0ADDR)

Bit	7	6	5	4	3	2	1	0
Field	COMP_ADDR							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F45H							

Bit	Description
[7:0] COMP_ADDR	**Compare Address** This 8-bit value is compared to incoming address bytes.

UART Baud Rate High and Low Byte Registers

The UART Baud Rate High (UxBRH) and Low Byte (UxBRL) registers, shown in Tables 70 and 71, combine to create a 16-bit baud rate divisor value (BRG[15:0]) that sets the data transmission rate (baud rate) of the UART.

Table 70. UART Baud Rate High Byte Register (U0BRH)

Bit	7	6	5	4	3	2	1	0
Field	BRH							
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F46H							

Bit	Description
[7:0] BRH	**UART Baud Rate High Byte**

Table 71. UART Baud Rate Low Byte Register (U0BRL)

Bit	7	6	5	4	3	2	1	0
Field	BRL							
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F47H							

Bit	Description
[7:0] BRL	**UART Baud Rate Low Byte**

Table 75. ADC Data High Byte Register (ADCD_H)

Bit	7	6	5	4	3	2	1	0
Field	ADCDH							
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
Address	F72H							
X = Undefined.								

Bit	Description
[7:0] ADCDH	**ADC Data High Byte** This byte contains the upper eight bits of the ADC output. These bits are not valid during a single-shot conversion. During a continuous conversion, the most recent conversion output is held in this register. These bits are undefined after a Reset.

ADC Data Low Byte Register

The ADC Data Low Byte (ADCD_L) Register contains the lower bits of the ADC output plus an overflow status bit. The output is a 13-bit two's complement value. During a single-shot conversion, this value is invalid. Access to the ADC Data Low Byte Register is read-only. Reading the ADC Data High Byte Register latches data in the ADC Low Bits Register.

Table 76. ADC Data Low Byte Register (ADCD_L)

Bit	7	6	5	4	3	2	1	0
Field	ADCDL					Reserved		OVF
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
Address	F73H							
X = Undefined.								

Bit	Description
[7:3] ADCDL	**ADC Data Low Bits** These bits are the least significant five bits of the 13-bits of the ADC output. These bits are undefined after a Reset.

Trim Bit Address 0002H

Table 92. Trim Option Bits at 0002H (TIPO)

Bit	7	6	5	4	3	2	1	0
Field	IPO_TRIM							
RESET	U							
R/W	R/W							
Address	Information Page Memory 0022H							

Note: U = Unchanged by Reset. R/W = Read/Write.

Bit	Description
[7:0] IPO_TRIM	**Internal Precision Oscillator Trim Byte** Contains trimming bits for the Internal Precision Oscillator.

Trim Bit Address 0003H

Note: The LVD is available on 8-pin devices only.

Table 93. Trim Option Bits at Address 0003H (TLVD)

Bit	7	6	5	4	3	2	1	0
Field	Reserved			LVD_TRIM				
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Information Page Memory 0023H							

Note: U = Unchanged by Reset. R/W = Read/Write.

Bit	Description
[7:5]	**Reserved** These bits are reserved and must be programmed to 111.
[4:0] LVD_TRIM	**Low Voltage Detect Trimm** This trimming affects the low voltage detection threshold. Each LSB represents a 50mV change in the threshold level. Alternatively, the low voltage threshold may be computed from the options bit value by the following equation: $LVD\_LVL = 3.6\ V - LVD\_TRIM \times 0.05\ V$ These values are tabulated in Table 94.

On-Chip Debugger

The Z8 Encore! XP F082A Series devices contain an integrated On-Chip Debugger (OCD) that provides advanced debugging features including:

- Single pin interface
- Reading and writing of the register file
- Reading and writing of program and data memory
- Setting of breakpoints and watchpoints
- Executing eZ8 CPU instructions
- Debug pin sharing with general-purpose input-output function to maximize pins available to the user (8-pin product only)

Architecture

The on-chip debugger consists of four primary functional blocks: transmitter, receiver, auto-baud detector/generator and debug controller. Figure 23 displays the architecture of the on-chip debugger.

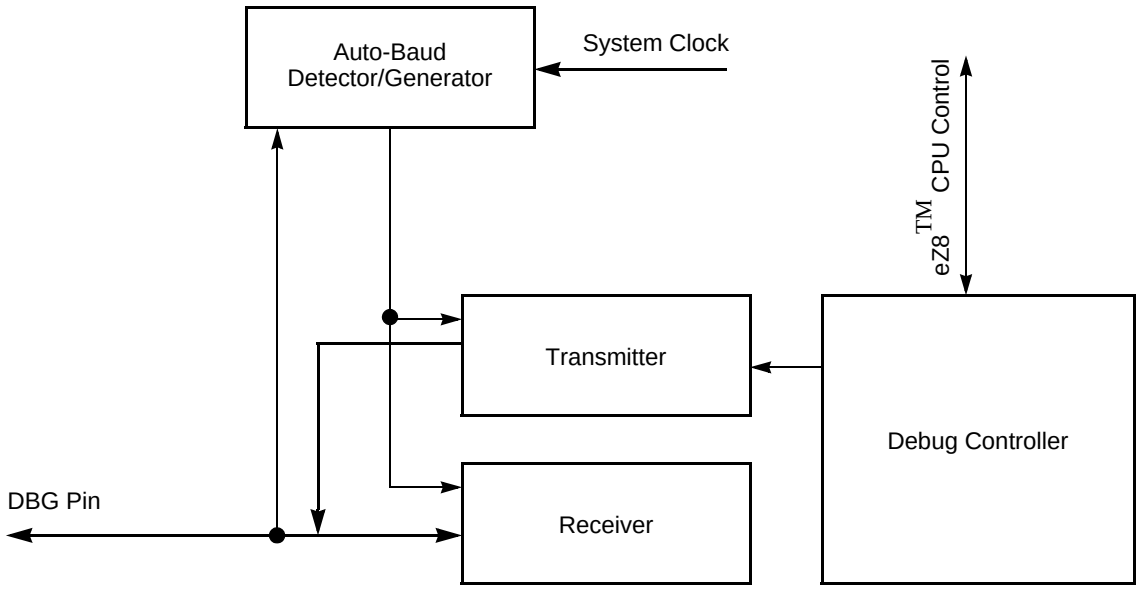

Figure 23. On-Chip Debugger Block Diagram

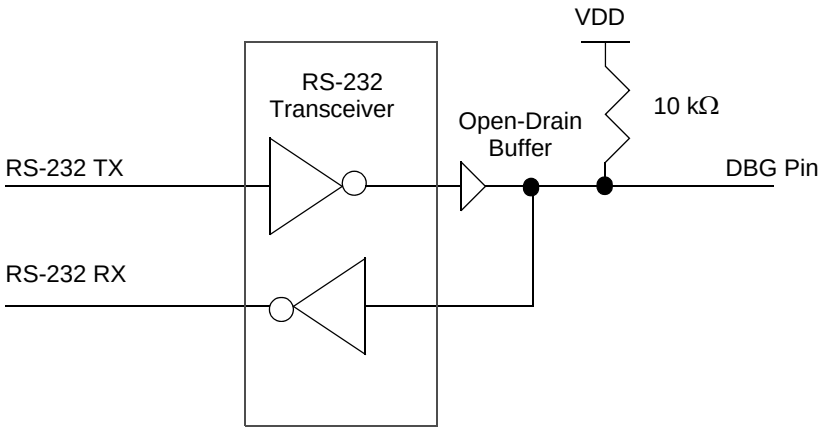

Figure 25. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface; #2 of 2

DEBUG Mode

The operating characteristics of the devices in DEBUG Mode are:

- The eZ8 CPU fetch unit stops, idling the eZ8 CPU, unless directed by the OCD to execute specific instructions
- The system clock operates unless in STOP Mode
- All enabled on-chip peripherals operate unless in STOP Mode
- Automatically exits HALT Mode
- Constantly refreshes the Watchdog Timer, if enabled

Entering DEBUG Mode

The operating characteristics of the devices entering DEBUG Mode are:

- The device enters DEBUG Mode after the eZ8 CPU executes a BRK (Breakpoint) instruction
- If the DBG pin is held Low during the final clock cycle of system reset, the part enters DEBUG Mode immediately (20-/28-pin products only)

Note: Holding the DBG pin Low for an additional 5000 (minimum) clock cycles after reset (making sure to account for any specified frequency error if using an internal oscillator) prevents a false interpretation of an Autobaud sequence (see the OCD Auto-Baud Detector/Generator section on page 183).

Internal Precision Oscillator

The internal precision oscillator (IPO) is designed for use without external components. You can either manually trim the oscillator for a nonstandard frequency or use the automatic factory-trimmed version to achieve a 5.53MHz frequency. IPO features include:

- On-chip RC oscillator that does not require external components
- Output frequency of either 5.53MHz or 32.8kHz (contains both a fast and a slow mode)
- Trimmed through Flash option bits with user override
- Elimination of crystals or ceramic resonators in applications where very high timing accuracy is not required

Operation

An 8-bit trimming register, incorporated into the design, compensates for absolute variation of oscillator frequency. Once trimmed the oscillator frequency is stable and does not require subsequent calibration. Trimming is performed during manufacturing and is not necessary for you to repeat unless a frequency other than 5.53MHz (fast mode) or 32.8kHz (slow mode) is required. This trimming is done at +30ºC and a supply voltage of 3.3V, so accuracy of this operating point is optimal.

If not used, the IPO can be disabled by the Oscillator Control Register (see the Oscillator Control Register Definitions section on page 196).

By default, the oscillator frequency is set by the factory trim value stored in the write-protected Flash information page. However, the user code can override these trim values as described in the Trim Bit Address Space section on page 165.

Select one of two frequencies for the oscillator (5.53MHz and 32.8kHz) using the OSCSEL bits in the the Oscillator Control chapter on page 193.

Register file size varies depending on the device type. See the device-specific Z8 Encore! XP Product Specification to determine the exact register file range available.

eZ8 CPU Instruction Notation

In the eZ8 CPU Instruction Summary and Description sections, the operands, condition codes, status flags and address modes are represented by a notational shorthand that is described in Table 118.

Table 118. Notational Shorthand

Notation	Description	Operand	Range
b	Bit	b	b represents a value from 0 to 7 (000B to 111B).
cc	Condition code	—	Refer to the Condition Codes section in the eZ8 CPU Core User Manual (UM0128).
DA	Direct address	Addrs	Represents a number in the range 0000H to FFFFH.
ER	Extended addressing register	Reg	Reg. represents a number in the range of 000H to FFFH.
IM	Immediate data	#Data	Data is a number between 00H to FFH.
Ir	Indirect working register	@Rn	n = 0–15.
IR	Indirect register	@Reg	Reg. represents a number in the range of 00H to FFH.
Irr	Indirect working register pair	@RRp	p = 0, 2, 4, 6, 8, 10, 12, or 14.
IRR	Indirect register pair	@Reg	Reg. represents an even number in the range 00H to FEH.
p	Polarity	p	Polarity is a single bit binary value of either 0B or 1B.
r	Working register	Rn	n = 0 – 15.
R	Register	Reg	Reg. represents a number in the range of 00H to FFH.
RA	Relative address	X	X represents an index in the range of +127 to –128 which is an offset relative to the address of the next instruction.
rr	Working register pair	RRp	p = 0, 2, 4, 6, 8, 10, 12, or 14.
RR	Register pair	Reg	Reg. represents an even number in the range of 00H to FEH.

Table 128. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
AND dst, src	dst ← dst AND src	r	r	52	–	*	*	0	–	–	2	3
		r	Ir	53							2	4
		R	R	54							3	3
		R	IR	55							3	4
		R	IM	56							3	3
		IR	IM	57							3	4
ANDX dst, src	dst ← dst AND src	ER	ER	58	–	*	*	0	–	–	4	3
		ER	IM	59							4	3
ATM	Block all interrupt and DMA requests during execution of the next 3 instructions			2F	–	–	–	–	–	–	1	2
BCLR bit, dst	dst[bit] ← 0	r		E2	–	–	–	–	–	–	2	2
BIT p, bit, dst	dst[bit] ← p	r		E2	–	–	–	–	–	–	2	2
BRK	Debugger Break			00	–	–	–	–	–	–	1	1
BSET bit, dst	dst[bit] ← 1	r		E2	–	–	–	–	–	–	2	2
BSWAP dst	dst[7:0] ← dst[0:7]	R		D5	X	*	*	0	–	–	2	2
BTJ p, bit, src, dst	if src[bit] = p PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4
BTJNZ bit, src, dst	if src[bit] = 1 PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4
BTJZ bit, src, dst	if src[bit] = 0 PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4

Note: Flags Notation:
* = Value is a function of the result of the operation.
– = Unaffected.
X = Undefined.
0 = Reset to 0.
1 = Set to 1.

Upper Nibble (Hex) \ Lower Nibble (Hex)	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0																
1																
2																
3																
4																
5																
6																
7	3,															
8																
9																
A			3.3 **CPC** r1,r2	3.4 **CPC** r1,Ir2	4.3 **CPC** R2,R1	4.4 **CPC** IR2,R1	4.3 **CPC** R1,IM	4.4 **CPC** IR1,IM	5.3 **CPCX** ER2,ER1	5.3 **CPCX** IM,ER1						
B																
C	3.2 **SRL** R1	3.3 **SRL** IR1														
D																
E									5, 4 **LDWX** ER2,ER1							
F																

Figure 32. Second Opcode Map after 1FH

Table 131. DC Characteristics (Continued)

		T_A = –40°C to +105°C (unless otherwise specified)				
Symbol	**Parameter**	**Minimum**	**Typical**	**Maximum**	**Units**	**Conditions**
V_{OH1}	High Level Output Voltage	2.4	–	–	V	I_{OH} = -2 mA; V_{DD} = 3.0 V High Output Drive disabled.
V_{OL2}	Low Level Output Voltage	–	–	0.6	V	I_{OL} = 20 mA; V_{DD} = 3.3V High Output Drive enabled.
V_{OH2}	High Level Output Voltage	2.4	–	–	V	I_{OH} = -20 mA; V_{DD} = 3.3V High Output Drive enabled.
I_{IH}	Input Leakage Current	–	±0.002	±5	µA	V_{IN} = V_{DD} V_{DD} = 3.3V;
I_{IL}	Input Leakage Current	–	±0.007	±5	µA	V_{IN} = V_{SS} V_{DD} = 3.3V;
I_{TL}	Tristate Leakage Current	–	–	±5	µA	
I_{LED}	Controlled Current Drive	1.8	3	4.5	mA	{AFS2,AFS1} = {0,0}
		2.8	7	10.5	mA	{AFS2,AFS1} = {0,1}
		7.8	13	19.5	mA	{AFS2,AFS1} = {1,0}
		12	20	30	mA	{AFS2,AFS1} = {1,1}
C_{PAD}	GPIO Port Pad Capacitance	–	8.0[2]	–	pF	
C_{XIN}	XIN Pad Capacitance	–	8.0[2]	–	pF	
C_{XOUT}	X_{OUT} Pad Capacitance	–	9.5[2]	–	pF	
I_{PU}	Weak Pull-up Current	30	100	350	µA	V_{DD} = 3.0 V–3.6 V
V_{RAM}	RAM Data Retention Voltage	TBD			V	Voltage at which RAM retains static values; no reading or writing is allowed.

Notes:
1. This condition excludes all pins that have on-chip pull-ups, when driven Low.
2. These values are provided for design guidance only and are not tested in production.

Figure 38 and Table 147 provide timing information for UART pins for the case where CTS is not used for flow control. DE asserts after the Transmit Data Register has been written. DE remains asserted for multiple characters as long as the Transmit Data Register is written with the next character before the current character has completed.

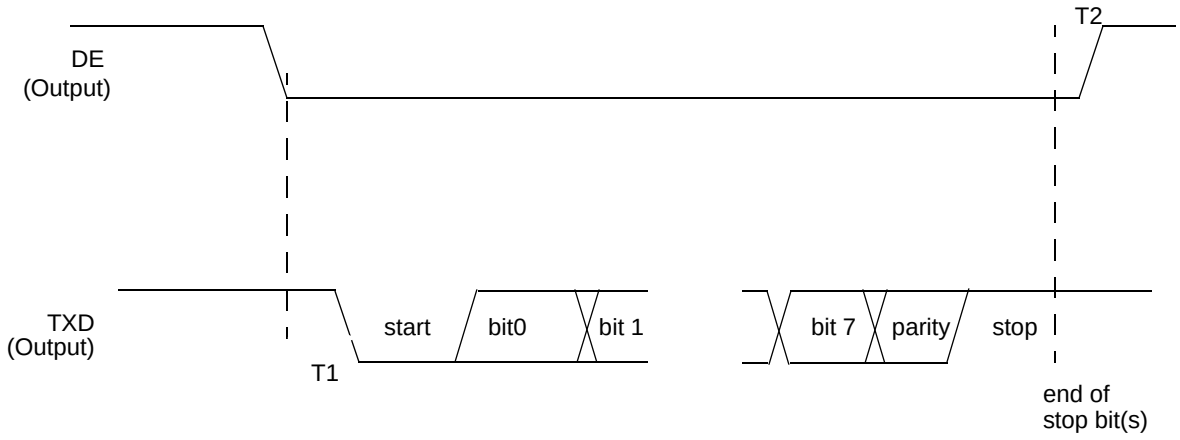

Figure 38. UART Timing Without CTS

Table 147. UART Timing Without CTS

		Delay (ns)	
Parameter	**Abbreviation**	**Minimum**	**Maximum**
UART			
T_1	DE assertion to TXD falling edge (start bit) delay	1 * X_{IN} period	1 bit time
T_2	End of Stop Bit(s) to DE deassertion delay (Tx Data Register is empty)	± 5	

G

H

I